

SOD-123FL Plastic-Encapsulate Diodes

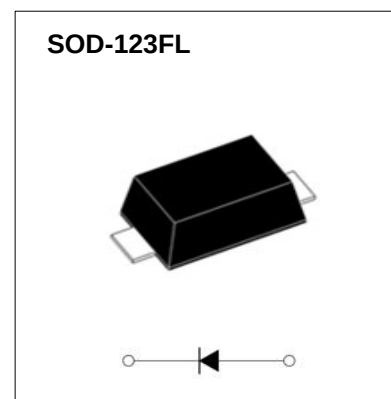
Super Fast Recovery Rectifier Diode

Features

- I_O 1A
- VRRM 200V-600V
- Low forward voltage drop
- High surge current capability
- Glass passivated chip junction

Mechical Data

- Case: SOD-123FL molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL- STD-202, Method 208
- Polarity: Color band denotes cathode end



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	MUR		
				S120	S140	S160
Repetitive Peak Reverse Voltage	V_{RRM}	V		200	400	600
Maximum RMS Voltage	V_{RMS}	V		140	280	420
Maximum DC blocking Voltage	V_{DC}	V		200	400	600
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_L = 100^\circ\text{C}$	1.0		
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave, 1 cycle, $T_a = 25^\circ\text{C}$	30		
Junction Temperature	T_J	$^\circ\text{C}$		-55~+150		
Storage Temperature	T_{STG}	$^\circ\text{C}$		- 55~+150		

Electrical Characteristics ($T_a = 25^\circ\text{C}$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		MUR		
					S120	S140	S160
Peak Forward Voltage	V _{FM}	V	I _{FM} =1.0A		0.875	1.25	
Peak Reverse Current	I _{RRM1}	μA	V _{RM} =V _{RRM}	T _a =25℃	2	5	
	T _a =125℃			50			
Reverse Recovery time	t _{rr}	ns	I _F =0.5A I _R =1A I _{RR} =0.25A		25	50	
Thermal Resistance(Typical)	R _{θJ-A}	℃/W	Between junction and ambient		85		
	Between junction and lead		23				
	Between junction and case		15				

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

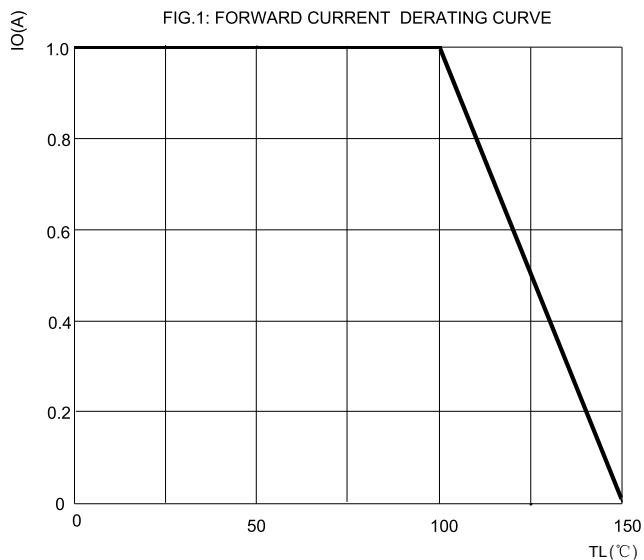


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

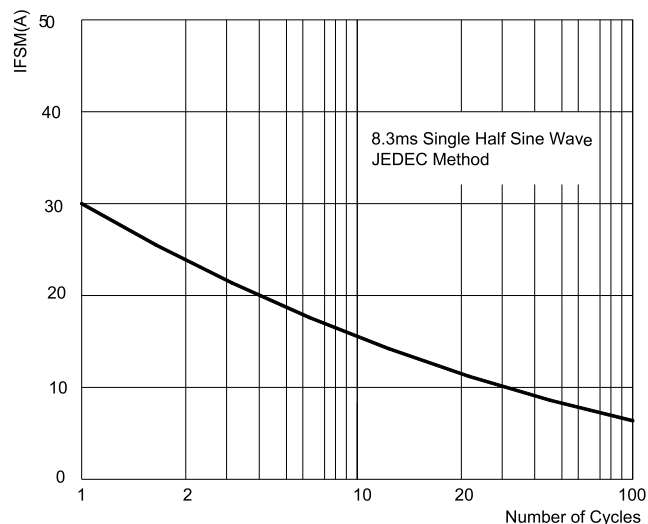


FIG.3: TYPICAL FORWARD CHARACTERISTICS

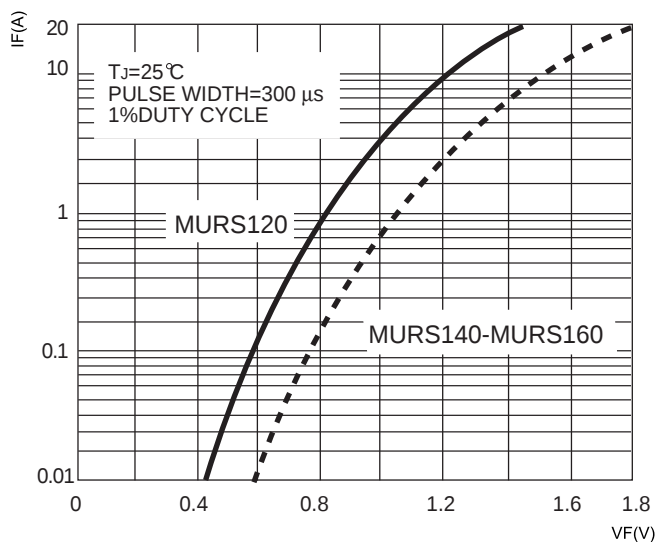


FIG.4: TYPICAL REVERSE CHARACTERISTICS

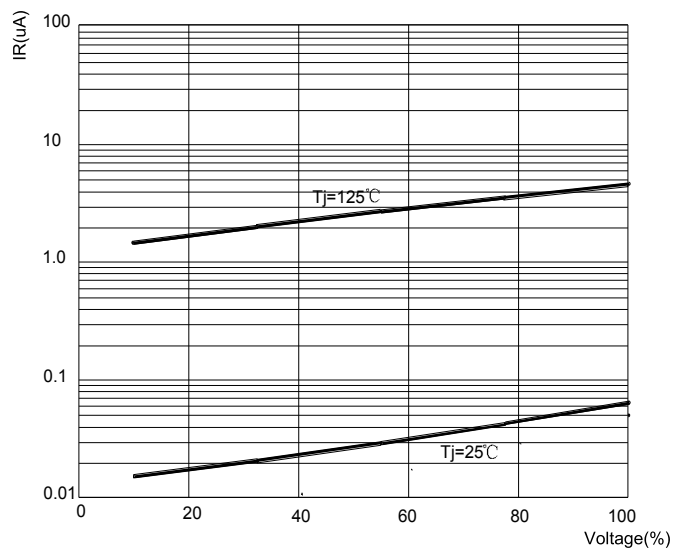
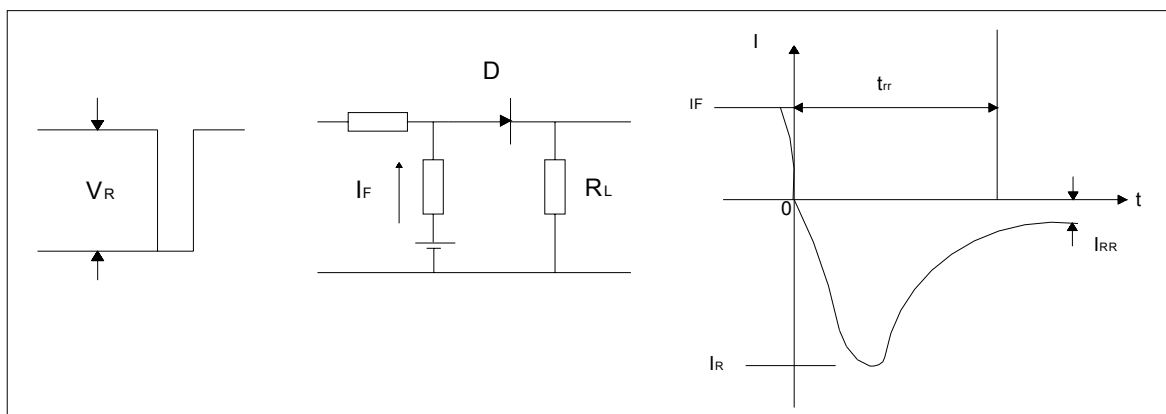
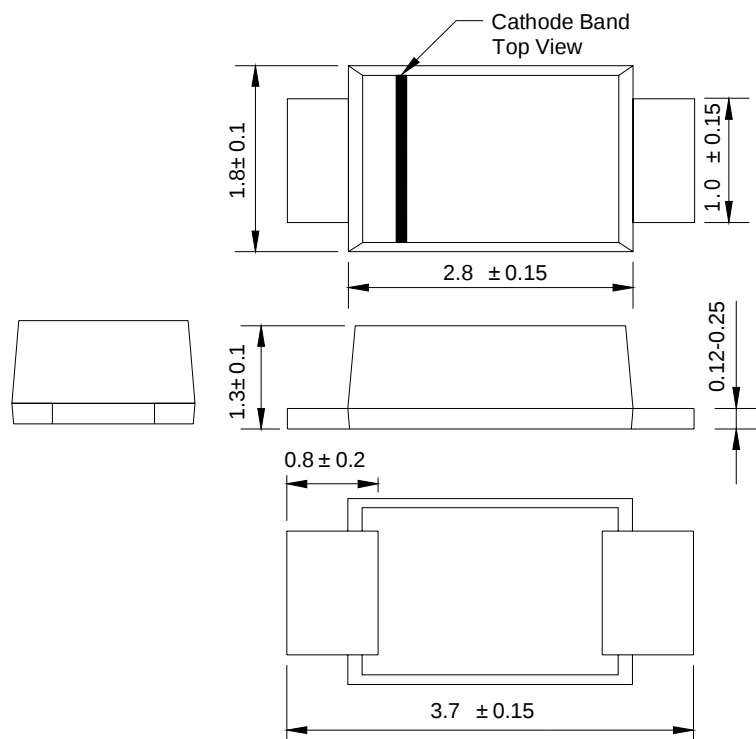


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time

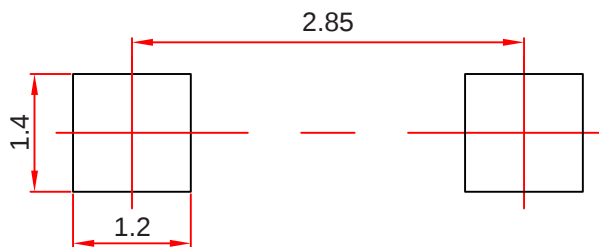


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



- Note:**
- 1. Controlling dimension: in millimeters.
 - 2. General tolerance: ± 0.05 mm.
 - 3. The pad layout is for reference purposes only.

Ordering Information

Part Number	Package	Shipping Quantity
MURS120 -MURS160	SOD-123FL	3000/tape&Reel

Marking Diagram



XX: From 20 To 60

Reel Taping Specifications For Surface Mount Devices–SOD-123FL

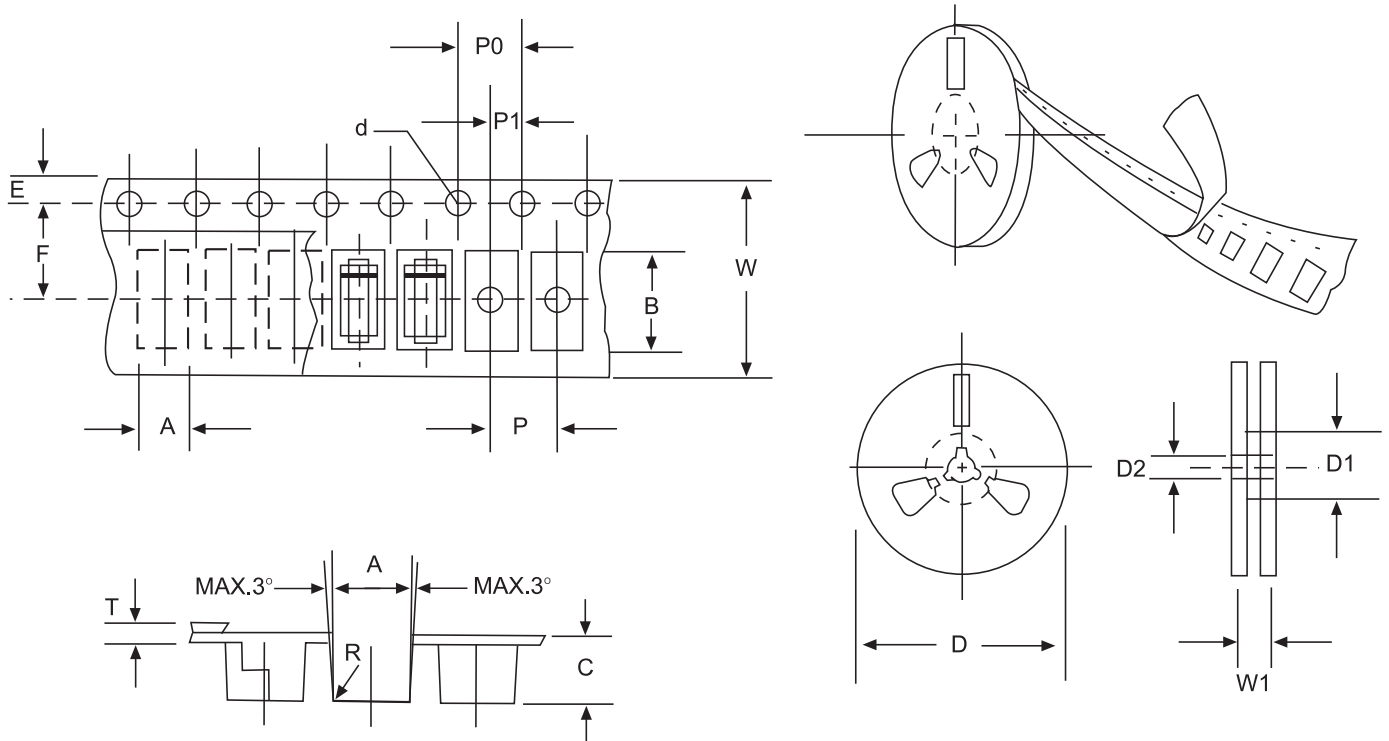


FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.